What is claimed is:

- 1. A light-emitting semiconductor device comprising:
- a first reflection film to reflect light with a wavelength δ
 - a light emitting layer formed on said first reflection film, said light-emitting layer being injected with electric current to emit light with a wavelength of about λ ;
- a second reflection film formed on said light-emitting
 layer to reflect the light with the wavelength λ, said second
 reflection film being provided with a periodical structure
 alternately stacked with a first semiconductor layer and a second
 semiconductor layer, wherein a reflectivity with respect to the light
 with the wavelength λ of said second reflection film is lower than
 that of said first reflection film;
 - an electric current spreading layer formed on said second reflection film to transmit the light with the wavelength λ , said electric current spreading layer being the same electronic conduction type as said second reflection film and having not less than half of a thickness of said second reflection film;
 - a contact layer formed on said electric current spreading layer, said contact layer being the same electronic conduction type as said second reflection film; and
- a high resistance region formed in a part of said second reflection film.

- 2. A light-emitting semiconductor device according to Claim 1, wherein said light-emitting semiconductor device is capable of operating at a speed of not less than 500 Mbps.
- 3. A light-emitting semiconductor device according to Claim 1, wherein said first semiconductor is made of a III-V group compound semiconductor and said second semiconductor is made of a III-V group compound semiconductor in which a V group element is common with that of said first semiconductor.

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- 4. A light-emitting semiconductor device according to Claim 2, wherein said first semiconductor is made of a III-V group compound semiconductor and said second semiconductor is made of a III-V group compound semiconductor in which a V group element is common with that of said first semiconductor.
- 5. A light-emitting semiconductor device according to Claim 1, wherein said first semiconductor is made of AljGa1-jAs, (0 \leq j), and said second semiconductor is made of AlkGa1-kAs, (j <k \leq 1), and said electric current spreading layer is made of AlzGa1-zAs, (0 \leq z \leq 1).
- 6. A light-emitting semiconductor device according to Claim 2, wherein said first semiconductor is made of AljGa1-jAs, (0 ≤ j), and said second semiconductor is made of AlkGa1-kAs, (j <k ≤ 1), and said electric current spreading layer is made of AlzGa1-zAs,

 $(0 \le z \le 1).$

- 7. A light-emitting semiconductor device according to Claim 3, wherein said first semiconductor is made of AljGa1-jAs, (0 \leq j), and said second semiconductor is made of AlkGa1-kAs, (j <k \leq 1), and said electric current spreading layer is made of AlzGa1-zAs, (0 \leq z \leq 1).
- 8. A light-emitting semiconductor device according to Claim 4, wherein said first semiconductor is made of AljGa1-jAs, (0 ≤ j), and said second semiconductor is made of AlkGa1-kAs, (j <k ≤ 1), and said electric current spreading layer is made of AlzGa1-zAs, (0 ≤ z ≤ 1).
- 9. A light-emitting semiconductor device according to Claim 1, wherein said second reflection film is made of a III-V group compound semiconductor in which an average Al composition is not less than 0.4 and said electric current spreading layer is made of a III-V group compound semiconductor in which an Al composition is not less than 0.2.
 - 10. A light-emitting semiconductor device according to Claim 2, wherein said second reflection film is made of a III-V group compound semiconductor in which an average Al composition is not less than 0.4 and said electric current spreading layer is made of a III-V group compound semiconductor in which an Al

composition is not less than 0.2.

- 11. A light-emitting semiconductor device according to Claim 9, wherein said first semiconductor is made of AljGa1·jAs, (0 \leq j), and said second semiconductor is made of AlkGa1·kAs, (j <k \leq 1), and said electric current spreading layer is made of Ind(Ga1·cAlc)1·dP, (0 < c \leq 1, 0 \leq d <1).
- 12. A light-emitting semiconductor device according to
 10 Claim 10, wherein said first semiconductor is made of AljGa1-jAs,
 (0 ≤ j), and said second semiconductor is made of AlkGa1-kAs, (j <k
 ≤ 1), and said electric current spreading layer is made of Ind(Ga1-cAlc)1-dP, (0 < c ≤ 1, 0 ≤ d < 1).
- 13. A light-emitting semiconductor device according to Claim 1, wherein the number of stacked pairs of said first and second semiconductors ranges from 4 to 12.
- 14. A light-emitting semiconductor device according to
 20 Claim 3, wherein the number of stacked pairs of said first and
 second semiconductors ranges from 4 to 12.
 - 15. A light-emitting semiconductor device according to Claim 5, wherein the number of stacked pairs of said first and second semiconductors ranges from 4 to 12.

- 16. A light-emitting semiconductor device according to Claim 7, wherein the number of stacked pairs of said first and second semiconductors ranges from 4 to 12.
- 17. A light-emitting semiconductor device according to Claim 9, wherein the number of stacked pairs of said first and second semiconductors ranges from 4 to 12.
- 18. A light-emitting semiconductor device according to
 10 Claim 11, wherein the number of stacked pairs of said first and
 second semiconductors ranges from 4 to 12.

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